IPC Web Site for Information on IPC-1752 Standard Information IPC-1752 Standard IPC-17	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.						both This docum level parts,	Material Composition Declaration Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both and Pan-American copyright conventions.			IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES
Company name Com	ials and Mfg Information								n IPC-1752 Stan		752-21.1
Semi										ation	upplier Informa
Title - Contact* Product-Env-Stewards Product Enviro Compliance Phone - Representative* Product-Env-Stewards Produ	Response Date*			Unique ID Authority				ompany name* Company unique ID			
Product Env-Stewards Title - Representative* Product Enviro Compliance NA Product Env-Stewards @ onsemi.com Product-Env-Stewards @ onsemi.com NA Product-Env-Stewards @ onsemi.com NA Product-Env-Stewards @ onsemi.com NA Product-Env-Stewards @ onsemi.com NA Na Na Na Na Na Na Na Na	2025-07-13										nsemi
Title - Representative* Product Envi- Compliance Requester Item Number Mfr Item Number Mfr Item Name Requester Item Number Mr Item Name Requester Item Number Manufacturing Site Weight* UOM Requester Item Number Version Manufacturing Site Weight* UOM Requester Item Number Requester Item Number NA NA Requester Item Number Site Weight* UOM Requester Item Number NA	Email - Contact*				Phone - Contact*			nct	Title - Conta		ontact Name
Product-Env-Stewards Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM MC79M12BTG ANA 500MA 12V NEGATI VREG 2025-07-13 CNC 1365.61 mg Manufacturing Process Information Terminal Plating / Grid Array Material Terminal Base Alloy Terminal Plating / Grid Array Material Matte Tin (Sn) - annealed CU Alloy NA O C 30 Requester Item Number Weight* UOM Namufacturing Site Weight* UOM Namufacturing Site Weight* Version Manufacturing Site Weight* Version	Product-Env-Stewards@onsemi.com				NA			iro Compliance	duct-Env-Stewards Product Enviro Compliance		
Requester Item Number	Email - Representative*			Phone - Representative*				zed Representative* Title - Representative			uthorized Represent
MC79M12BTG ANA 500MA 12V NEGATI VREG 2025-07-13 CNC 1365.61 mg Institution	Product-Env-Stewards@onsemi.com			NA				oduct-Env-Stewards Product Enviro Compliance			roduct-Env-Steware
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3	Unit Type	ht* UOM	Weight*	Manufacturing Site	Version N	Effective Date		Mfr Item Name	em Number	Item Number Mfr It	Requester
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3	Each	61 mg	1365.61	CNC	C	2025-07-13	GATI VREG	ANA 500MA 12V NEGA	M12BTG	MC79	
Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3		N. J. CD G. C. J.		W T + D 17	D. I. T.	D 1 D	D 000 MGL D (All LOTTO OF	T : 1D		
France III (01) timester CC III (1) 1/11 C C CC CC CC CC CC	ycles	i -		<u> </u>		D-020 MSL Rating					
omments		<u>.</u> 3	seconds 3	30	<u> </u>	U		NA	CU Alloy	(Sn) - anneaied	
											omments
or more information regarding material composition please refer to page 3											

RoHS Material Composition Declaration		Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the									
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature Ra	astislav Drska	-En							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.61	mg	Supplier	Silicon (Si)	7440-21-3		1.61	mg
Die Attach	0.21	mg	A	Lead (Pb)	7439-92-1	7a	0.1995	mg
			Supplier	Tin (Sn)	7440-31-5		0.0105	mg
Lead Frame	677.24	mg	В	Nickel (Ni)	7440-02-0		0.3386	mg
			Supplier	Iron (Fe)	7439-89-6		0.6772	mg
			Supplier	Copper (Cu)	7440-50-8		676.0209	mg
			Supplier	Phosphorus (P)	7723-14-0		0.2032	mg
Mold Compound-Black	644.0	mg		Phenolic Resin	proprietary data		38.64	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		64.4	mg
			Supplier	Carbon Black (C)	1333-86-4		3.22	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		48.3	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		489.44	mg
Plating	42.4	mg	Supplier	Tin (Sn)	7440-31-5		42.4	mg
Wire Bond - Cu	0.15	mg	Supplier	Copper (Cu)	7440-50-8		0.15	mg